

# UT138E

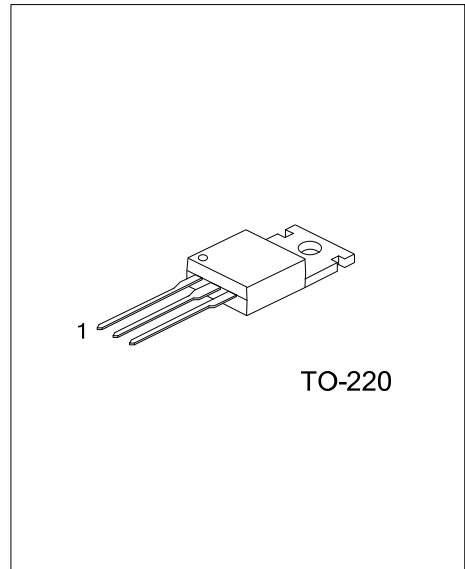
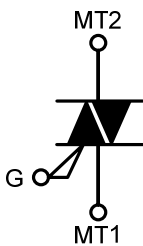
TRIAC

## TRIACS

### DESCRIPTION

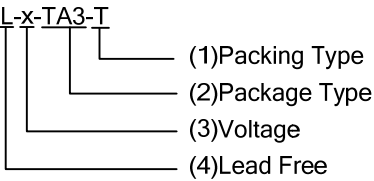
Glass passivated , sensitive gate triacs in a plastic envelope, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.

### SYMBOL



### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT138EL-x-TA3-T	UT138EG-x-TA3-T	TO-220	MT1	MT2	G	Tube

<p>UT138EL-x-TA3-T</p>  <ul style="list-style-type: none"> <li>(1)Packing Type</li> <li>(2)Package Type</li> <li>(3)Voltage</li> <li>(4)Lead Free</li> </ul>	<ul style="list-style-type: none"> <li>(1) T: Tube</li> <li>(2) TA3: TO-220</li> <li>(3) 5: 500V, 6: 600V, 8: 800V</li> <li>(4) L: Lead Free, G: Halogen Free</li> </ul>
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## ■ ABSOLUTE MAXIMUM RATING (T<sub>J</sub>=25°C)

PARAMETER	SYMBOL	RATINGS	UNIT	
Repetitive Peak Off State Voltag	V <sub>DRM</sub>	UT138E-5	500	V
		UT138E-6	600	V
		UT138E-8	800	V
RMS On-state Current (Full sine wave, T <sub>MB</sub> ≤99°C)	I <sub>T(RMS)</sub>	12	A	
Non-Repetitive Peak. On-State Current (Full sine wave, T <sub>J</sub> =25°C prior to surge)	I <sub>TSM</sub>	t=20mS	95	A
		t=16.7mS	105	A
I <sup>2</sup> t For Fusing (t=10ms)	I <sup>2</sup> t	45	A <sup>2</sup> s	
Repetitive Rate of Rise of On-state Current After Triggering (I <sub>TM</sub> =20A, I <sub>G</sub> =0.2A, dI <sub>G</sub> /dt=0.2A/μs)	dI <sub>T</sub> /dt	T2+ G+	50	A/μs
		T2+ G-	50	A/μs
		T2- G-	50	A/μs
		T2- G+	10	A/μs
Peak Gate Voltage	V <sub>GM</sub>	5	V	
Peak Gate Current	I <sub>GM</sub>	2	A	
Peak Gate Power	P <sub>GM</sub>	5	W	
Average Gate Power (Over any 20ms period)	P <sub>G(AV)</sub>	0.5	W	
Operating Junction Temperature	T <sub>J</sub>	125	°C	
Storage Temperature	T <sub>STG</sub>	-40~150	°C	

Notes: Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15A/μs.

## ■ THERMAL RESISTANCES

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Thermal Resistance, Junction to Mounting Base	θ <sub>JC</sub>			1.5	K/W
				2.0	
Thermal Resistance, Junction to Ambient In free air	θ <sub>JA</sub>		60		K/W

## ■ STATIC CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Gate Trigger Current	I <sub>GT</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A	T2+ G+		2.5	10	mA
			T2+ G-		4.0	10	
			T2- G-		5.0	10	
			T2- G+		11	25	
Latching Current	I <sub>L</sub>	V <sub>D</sub> =12V, I <sub>GT</sub> =0.1A	T2+ G+		3.2	30	mA
			T2+ G-		16	40	
			T2- G-		4.0	30	
			T2- G+		5.5	40	
Holding Current	I <sub>H</sub>	V <sub>D</sub> =12V, I <sub>GT</sub> =0.1A		4.0	30	mA	
On-State Voltage	V <sub>T</sub>	I <sub>T</sub> =15A		1.4	1.65	V	
Gate Trigger Voltage	V <sub>GT</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A		0.7	1.5	V	
		V <sub>D</sub> =400V, I <sub>T</sub> =0.1A, T <sub>J</sub> =125°C	0.25	0.4		V	
Off-state Leakage Current	I <sub>D</sub>	V <sub>D</sub> =V <sub>DRM(max)</sub> , T <sub>J</sub> =125°C		0.1	0.5	mA	

■ **DYNAMIC CHARACTERISTICS** ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Critical Rate Of Rise Of Off-State Voltage	$dV_D/dt$	$V_{DM}=67\% V_{DRM(max)}$ , $T_J=125^\circ\text{C}$ Exponential waveform, Gate open circuit		50		V/ $\mu\text{s}$
Gate Controlled Turn-on Time	$t_{gt}$	$I_{TM}=16\text{A}$ , $V_D=V_{DRM(max)}$ , $I_G=0.1\text{A}$ $dI_G/dt=5\text{A}/\mu\text{s}$		2		$\mu\text{s}$

■ TYPICAL CHARACTERISTICS

Figure 1. Maximum On-State Dissipation.  $P_{tot}$  vs RMS On-state Current,  $I_{T(RMS)}$ , Where  $\alpha$ =Conduction Angle.

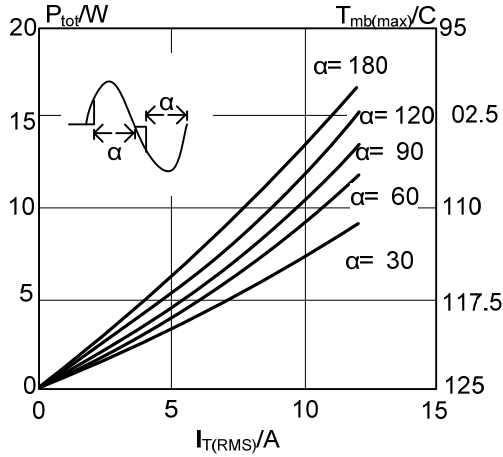


Figure 2. Maximum Permissible Non-Repetitive Peak On-State Current  $I_{TSM}$ , vs Pulse Width  $t_p$ , for Sinusoidal Currents,  $t_p \leq 20ms$ .

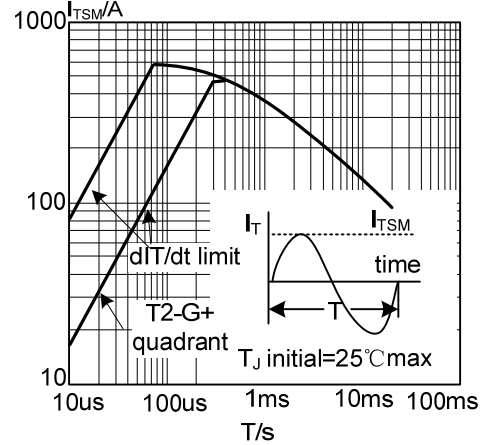


Figure 3. Maximum Permissible Non-Repetitive Peak On-State Current  $I_{TSM}$ , vs Number of Cycles, for Sinusoidal Currents,  $f=50Hz$ .

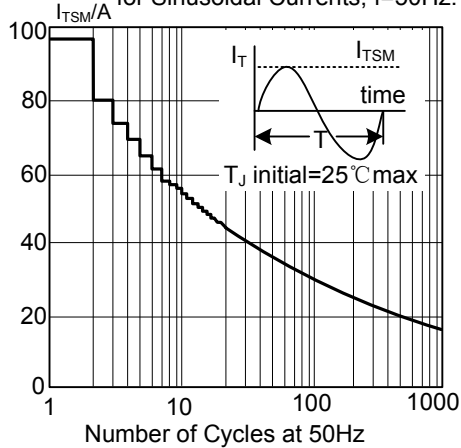


Figure 4. Maximum Permissible RMS Current  $I_{T(RMS)}$  vs Mounting Base Temperature  $T_{mb}$

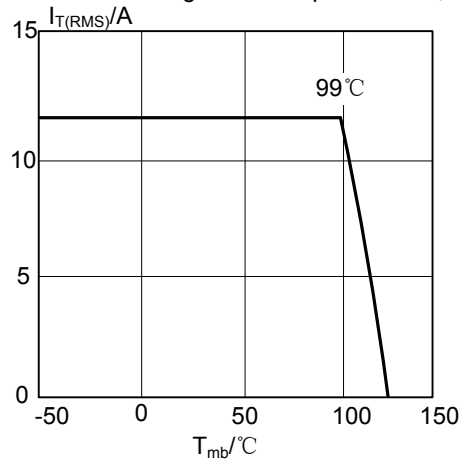


Figure 5. Maximum Permissible Repetitive RMS On-State Current  $I_{T(RMS)}$ , vs Surge Duration, for Sinusoidal Currents,  $f=50Hz$ ,  $T_{mb} \leq 99^\circ C$

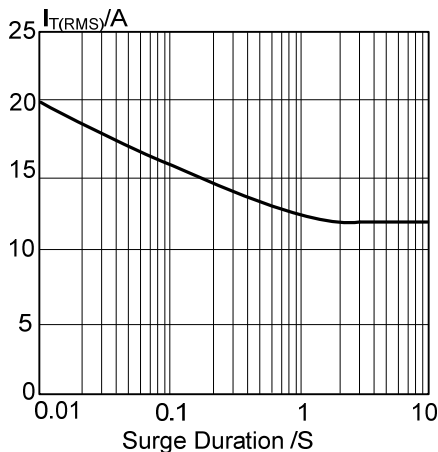
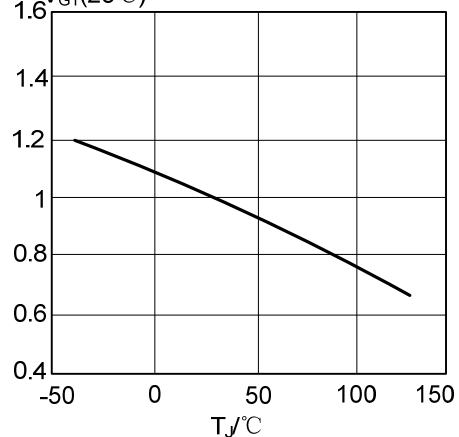


Figure 6. Normalised Gate Trigger Voltage  $V_{GT}(T_J)/V_{GT}(25^\circ C)$ , vs Junction Temperature  $T_J$



■ TYPICAL CHARACTERISTICS(Cont.)

Figure 7. Normalised Gate Trigger Current  $I_{GT}(T_J)/I_{GT}(25^\circ\text{C})$ , vs Junction Temperature  $T_J$ .

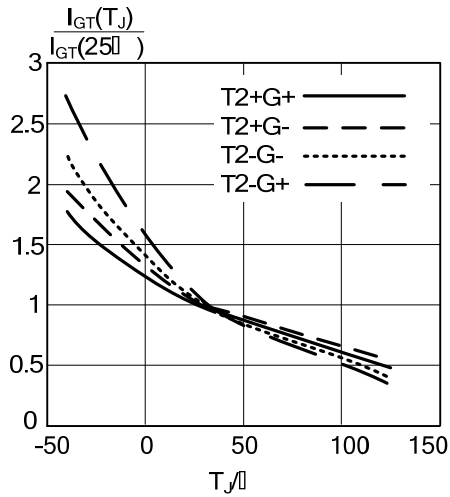


Figure 9. Normalised Holding Current  $I_H(T_J)/I_H(25^\circ\text{C})$ , vs Junction Temperature  $T_J$ .

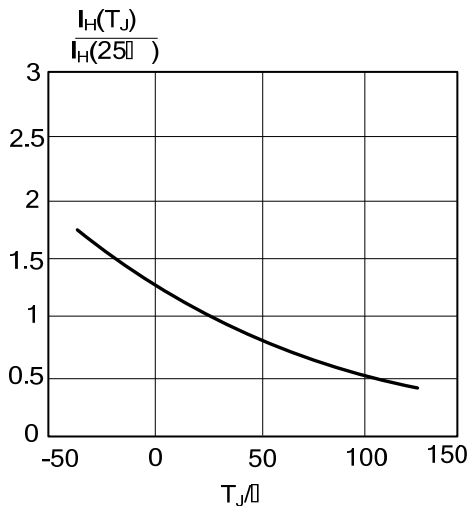


Figure 11. Transient Thermal Impedance  $Z_{th\ i-mb}$ , vs Pulse Width  $t_p$

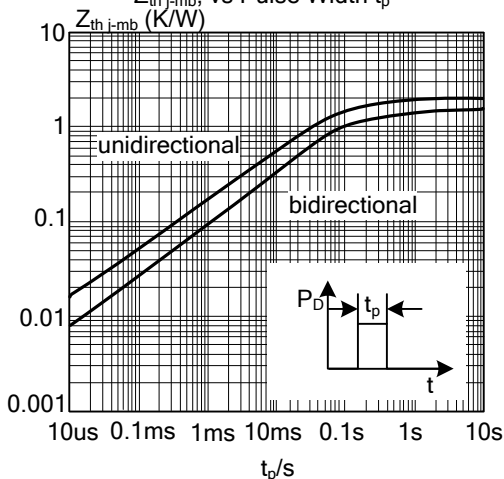


Figure 8. Normalised Latching Current  $I_L(T_J)/I_L(25^\circ\text{C})$ , vs Junction Temperature  $T_J$ .

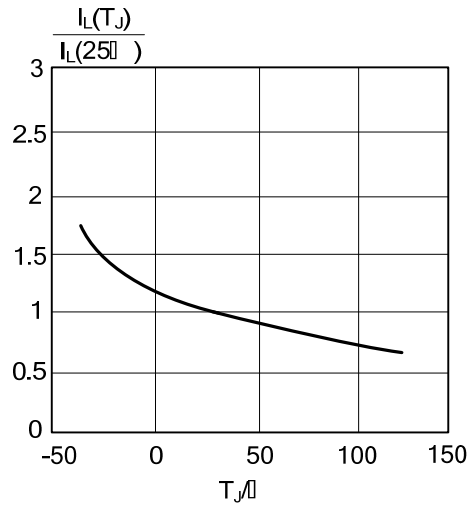


Figure 10. Typical and Maximum On-state Characteristic

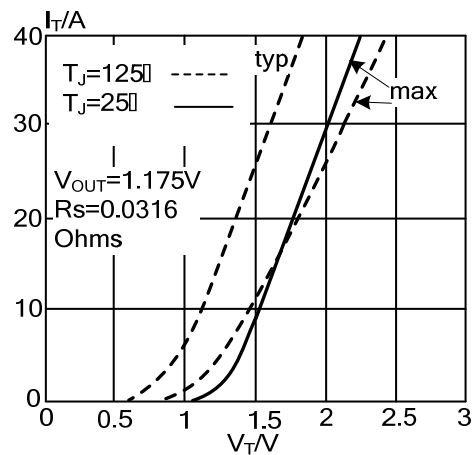
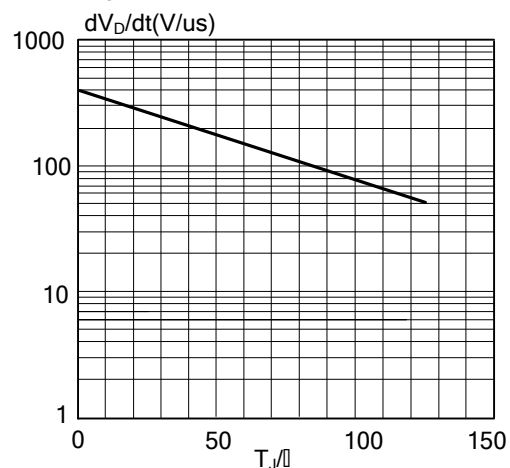


Figure 12. Typical Critical Rate of Rise of Off-State Voltage,  $dV_D/dt$  Versus Junction Temperature  $T_J$



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